This Page Is Inserted by IFW Operations and is not a part of the Official Record

BEST AVAILABLE IMAGES

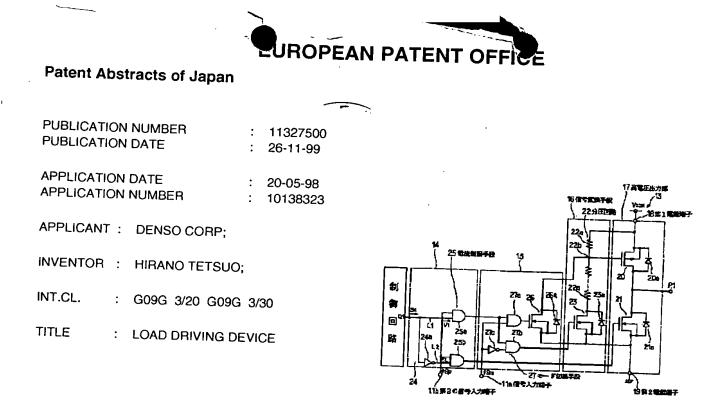
Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images may include (but are not limited to):

- BLACK BORDERS
- TEXT CUT OFF AT TOP, BOTTOM OR SIDES
- FADED TEXT
- ILLEGIBLE TEXT
- SKEWED/SLANTED IMAGES
- COLORED PHOTOS
- BLACK OR VERY BLACK AND WHITE DARK PHOTOS
- GRAY SCALE DOCUMENTS

IMAGES ARE BEST AVAILABLE COPY.

As rescanning documents *will not* correct images, please do not report the images to the Image Problem Mailbox.



ABSTRACT : PROBLEM TO BE SOLVED: To enable performing easily a test of an internal function despite of constitution in which a high breakdown voltage semiconductor switching element is included in an output stage turned on when high voltage is applied in an actual use state.

SOLUTION: A MOSFET 20 in a high voltage output section 17 of an output stage is turned on by a voltage divided signal Sd outputted from a voltage dividing circuit 22 in an on-state of a MOSFET 23 in a voltage level conversion section 16, and a MOSFET 21 in a high voltage output section 17 is turned on by a second voltage signal V₂ given from a through current control section 14. A low voltage operation control section 15 has a MOSFET 26 connecting an output terminal 22b of the voltage dividing circuit 22 to a second power source terminal 19 in an on-state and a signal switching circuit 27 which can switch a normal use mode or a test mode by a mode switching signal Sm given to a mode switching terminal 11a. A signal switching circuit 27 gives a first voltage signal V₁ given from the through current control section 14 to a MOSFET 26 when the device is in a test mode, and gives a first voltage signal V₁ to a MOSFET 23 when the device is in a normal use mode.

COPYRIGHT: (C)1999, JPO